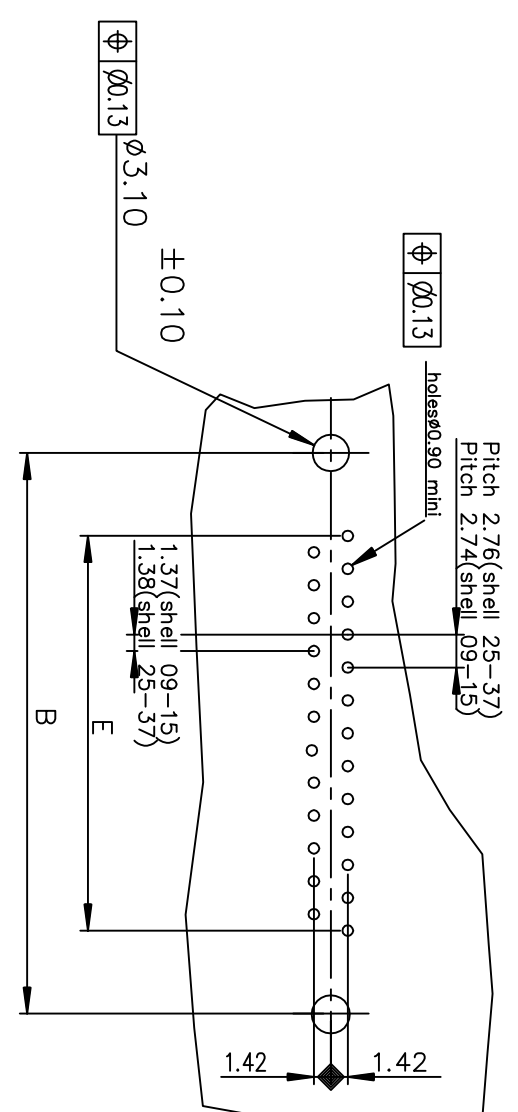


PC card drilling dimensions(after plating)  
(thickness 1.60±0.20mm)



LEAD FREE PART NUMBER

SHELL	A±0.38	B±0.12	C±0.10	D±0.25	E±0.07	G	200 Mating	500 Mating
09	30.81	24.99	16.96	16.79	10.96	5.90±0.15	D09P33E4G*09LF	D09P33E6G*09LF
15	39.14	33.32	25.18	25.12	19.18	5.90±0.15	D25P33E4G*09LF	D15P33E6G*09LF
25	53.03	47.04	39.12	38.84	33.12	5.70±0.25	D25P33E4G*09LF	D25P33E6G*09LF
37	69.32	63.50	55.68	55.30	49.68	5.70±0.25	D37P33E4G*09LF	D37P33E6G*09LF

L --->ØT=M3  
X -->ØT=UNC 4-40

Technical characteristics:  
Insulators: self-extinguishing thermoplastic, ULclass94V0, IR or reflow process compatible  
Climatic characteristics:  
Operating temperature range: -55°C +125°C

The housing will withstand exposure to 260°C peak temperature for 30 seconds in a convection, infra-red or vapor reflow over solder application

FOR ALL OTHER DETAILS REFER DWG.NO: C01-8646-0000

mat'l. code		surface		tolerance		projection		product family	
ISO 1302		ISO 406 ISO 1101		MM		D-SUB		title	
ISO 1302		ISO 406 ISO 1101		MM		D-SUB		MALE CONNECTOR DD RA (US) HIGH TEMPERATURE INSULATOR	
ltr	ecn no	dr	date	angles	linear	scale	dwg no	sheet 1 of 1	size
A	-	AB	2015-07-23	0±0.1	.00±0.1	2:1	10136292	A3	
B	ELX-1-22041	AB	2015-09-23	0±1°	.000±0.1				
sheet index		revision	sheet	type		Product Customer Drawing			
1		B	1	Product Customer Drawing					